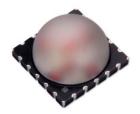


High Luminous Efficacy RGBA LED Emitter

LZC-03MA07



Key Features

- Ultra-bright, Ultra-compact 40W RGBA LED
- Individually addressable Red, Green, Blue and Amber channels
- Small high density foot print 9.0mm x 9.0mm
- Surface mount ceramic package with integrated glass lens
- Exceptionally low Thermal Resistance (0.7°C/W)
- Electrically neutral thermal path
- Extreme Luminous Flux density
- JEDEC Level 1 for Moisture Sensitivity Level
- Lead (Pb) free and RoHS compliant
- Reflow solderable (up to 6 cycles)
- Emitter available on 4-channel MCPCB (optional)
- Recommended use with LLxx-3T08 family of High Efficiency / High Uniformity color-mixing lenses for perfect color uniformity from 8 to 32 deg.

Typical Applications

- Architectural lighting
- Entertainment
- Stage and Studio lighting
- Accent lighting

Description

The LZC-03MA07 RGBA LED emitter enables a full spectrum of brilliant colors with the highest light output, highest flux density, and superior color mixing available. It outperforms other colored lighting solutions with multiple red, green, blue and amber LED die in a single, compact emitter. With 40W power capability and a 9.0mm x 9.0mm ultra-small footprint, this package provides exceptional luminous flux density. LED Engin's RGBA LED offers ultimate design flexibility with four individually addressable color channels. The patented design with thermally and electrically isolated pads has unparalleled thermal and optical performance. The high quality materials used in the package are chosen to optimize light output and minimize stresses which results in monumental reliability and lumen maintenance. The robust product design thrives in outdoor applications with high ambient temperatures and high humidity.

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LZC-03MA07 (1.5 - 03/17/16)



Part Number Options

Base part number

Part number	Description
LZC-03MA07-xxxx	LZC emitter
LZC-B3MA07-xxxx	LZC emitter on 4 channel 4x3 Star MCPCB

Bin kit option codes

	Min		
Kit number suffix	flux Bin	Color Bin Range	Description
0000	11R	R2 – R2	Red, full distribution flux; full distribution wavelength
	14G	G2 – G3	Green, full distribution flux; full distribution wavelength
	03B	B03 – B03	Blue, full distribution flux; full distribution wavelength
	11A	A9 – A9	Amber, full distribution flux; full distribution wavelength

Notes:

^{1.} Default bin kit option is -0000



Luminous Flux Bins

Table 1:

		Minin	Maximum					
		Luminous	Flux (Φ _ν)		Luminous Flux (Φ_{V})			
Bin Code		@ I _F = 700mA ^[1,2] (Im)				@ I _F = 70	0mA ^[1,2]	
						(lm)		
	3 Red	3 Green	3 Blue	3 Amber	3 Red	3 Green	3 Blue	3 Ambei
11R	260				420			
14G		300				480		
03B			48				77	
04B			77				130	
11A		•		240	•	•		400

Notes for Table 1:

Dominant Wavelength Bins

Table 2:

Bin Code	Minimum Dominant Wavelength (λ _D) @ I _F = 700mA ^[1,2]				Maximum Dominant Wavelength ($λ_D$) @ $I_F = 700$ mA ^[1,2]			
				(nm) (nm)				
	Red	Green ^[2]	Blue	Amber	Red	Green ^[2]	Blue	Amber
R2	618				630			
G2		520				525		
G3		525				530		
B03			453				460	
A9				590				595

Notes for Table 2:

Forward Voltage Bin

Table 3:

	Minimum				Maximum			
		Forward Voltage (V _F)			Forward Voltage (V _F)			
Bin Code	@ I _F = 700mA ^[1]			@ I _F = 700mA ^[1]				
		(\	')		(V)			
	Red	Green	Blue	Amber	Red	Green	Blue	Amber
0	6.00	9.30	9.30	6.00	8.00	12.00	12.00	8.00

Notes for Table 3:

- 1. Forward Voltage is binned with all three LED dice connected in series.
- 2. LED Engin maintains a tolerance of \pm 0.12V for forward voltage measurements for the three LEDs.

^{1.} Luminous flux performance guaranteed within published operating conditions. LED Engin maintains a tolerance of ±10% on flux measurements.

^{2.} Each flux value consists of 3 dies from the same color in series for binning purposes.

^{1.} LED Engin maintains a tolerance of ± 0.5nm on dominant wavelength measurements.



Absolute Maximum Ratings

Ta	bl	۵	۸.

Parameter	Symbol	Value	Unit		
DC Forward Current ^[1]	I _F	1000	mA		
Peak Pulsed Forward Current ^[2]	I _{FP}	1500	mA		
Reverse Voltage	V_R	See Note 3	V		
Storage Temperature	T _{stg}	-40 ~ +150	°C		
Junction Temperature [Blue, Green]	TJ	150	°C		
Junction Temperature [Red, Amber]	T _J	125	°C		
Soldering Temperature ^[4]	T_{sol}	260	°C		
Allowable Reflow Cycles		6			
FCD Consitivity [5]	> 8,000 V HBM				
ESD Sensitivity ^[5]	Class 3B JESD22-A114-D				

Notes for Table 4:

- Maximum DC forward current is determined by the overall thermal resistance and ambient temperature.
 Follow the curves in Figure 12 for current derating.
- 2: Pulse forward current conditions: Pulse Width ≤ 10msec and Duty Cycle ≤ 10%.
- 3. LEDs are not designed to be reverse biased.
- 4. Solder conditions per JEDEC 020D. See Reflow Soldering Profile Figure 5.
- 5. LED Engin recommends taking reasonable precautions towards possible ESD damages and handling the LZC-03MA07in an electrostatic protected area (EPA). An EPA may be adequately protected by ESD controls as outlined in ANSI/ESD S6.1.

Optical Characteristics @ T_C = 25°C

Table 5:

Dovomotov	C. mah al	Typical				l lmit
Parameter	Symbol	Red	Green	Blue ^[1]	Amber	Unit
Luminous Flux (@ I _F = 700mA)	Ф۷	340	430	100	320	lm
Luminous Flux (@ $I_F = 1000$ mA)	Ф۷	475	560	130	410	lm
Dominant Wavelength	λ_{D}	623	523	460	590	nm
Viewing Angle ^[2]	2Θ _½		95			Degrees
Total Included Angle ^[3]	Θ _{0.9}		115			Degrees

Notes for Table 5:

- 1. When operating the Blue LED, observe IEC 60825-1 class 2 rating. Do not stare into the beam.
- 2. Viewing Angle is the off axis angle from emitter centerline where the luminous intensity is ½ of the peak value.
- 3. Total Included Angle is the total angle that includes 90% of the total luminous flux.

Electrical Characteristics @ T_c = 25°C

Table 6:

Parameter	Symbol	Typical				Unit
rarameter	Syllibol	3 Red	3 Green	3 Blue	3 Amber	Ollit
Forward Voltage (@ I _F = 700mA) ^[1]	V _F	7.5	10.8	9.6	7.2	V
Forward Voltage (@ I _F = 1000mA) ^[1]	V _F	8.1	11.2	10.0	7.8	V
Temperature Coefficient of Forward Voltage	$\Delta V_F/\Delta T_J$	-5.7	-8.7	-9.0	-5.7	mV/°C
Thermal Resistance (Junction to Case)	RΘ _{J-C}		0.7			°C/W

Notes for Table 6:

Forward Voltage typical value is for three LED dice from the same color dice connected in series.



IPC/JEDEC Moisture Sensitivity Level

Table 7 - IPC/JEDEC J-STD-20D.1 MSL Classification:

				Soak Req	uirements	
	Floo	r Life	Stan	dard	Accel	erated
Level	Time	Conditions	Time (hrs)	Conditions	Time (hrs)	Conditions
1	Unlimited	≤ 30°C/ 85% RH	168 +5/-0	85°C/ 85% RH	n/a	n/a

Notes for Table 7:

Average Lumen Maintenance Projections

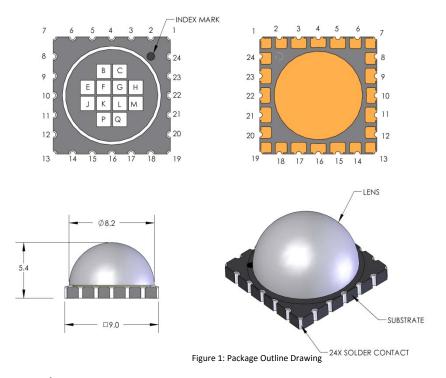
Lumen maintenance generally describes the ability of a lamp to retain its output over time. The useful lifetime for solid state lighting devices (Power LEDs) is also defined as Lumen Maintenance, with the percentage of the original light output remaining at a defined time period.

Based on long-term WHTOL testing, LED Engin projects that the LZ Series will deliver, on average, 70% Lumen Maintenance at 65,000 hours of operation at a forward current of 700 mA. This projection is based on constant current operation with junction temperature maintained at or below 125°C.

^{1.} The standard soak time includes a default value of 24 hours for semiconductor manufacturer's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.



Mechanical Dimensions (mm)



	Pin Out									
Pin	Die	Color	Polarity							
1	G	Red	+							
2	G	Red	-							
3	С	Green	+							
4	С	Green	-							
5	В	Amber	+							
6	В	Amber	-							
7	F	Blue	-							
8	F	Blue	+							
9	E	Green	+							
10	E	Green	-							
11	J	Red	-							
12	J	Red	+							
13	K	Amber	-							
14	K	Amber	+							
15	Р	Blue	-							
16	Р	Blue	+							
17	Q	Red	-							
18	Q	Red	+							
19	L	Green	+							
20	L	Green	-							
21	М	Blue	-							
22	М	Blue	+							
23	Н	Amber	+							
24	Н	Amber	-							

Notes for Figure 1:

Recommended Solder Pad Layout (mm)

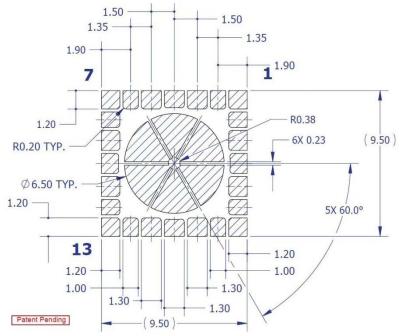


Figure 2a: Recommended solder pad layout for anode, cathode, and thermal pad.

Note for Figure 2a:

Unless otherwise noted, the tolerance = ± 0.20 mm.

^{1.} Unless otherwise noted, the tolerance = \pm 0.20 mm.



Recommended Solder Mask Layout (mm)

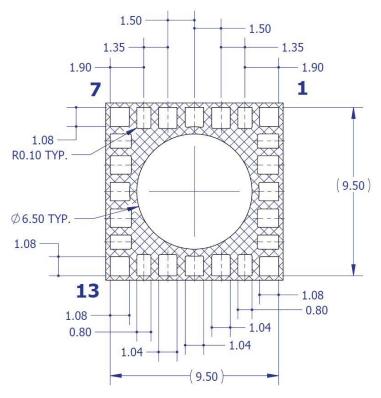


Figure 2b: Recommended solder mask opening (hatched area) for anode, cathode, and thermal pad.

Note for Figure 2b:

1. Unless otherwise noted, the tolerance = \pm 0.20 mm.

Reflow Soldering Profile

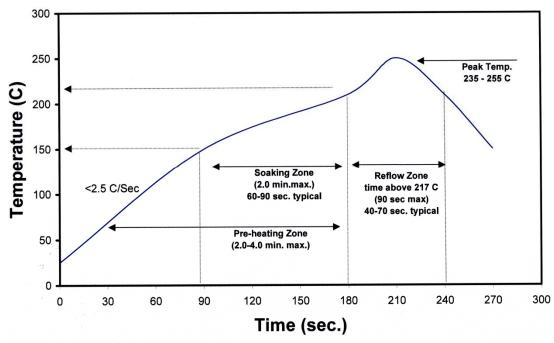


Figure 3: Reflow soldering profile for lead free soldering.



Typical Radiation Pattern

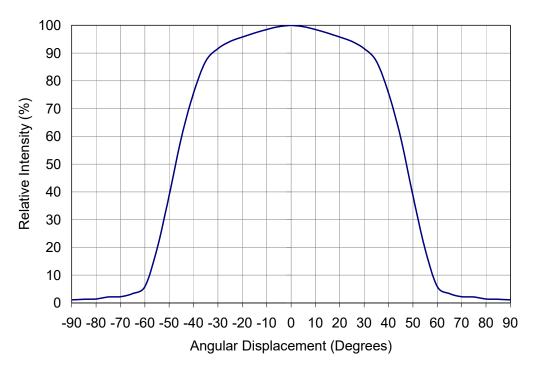


Figure 4: Typical representative spatial radiation pattern.

Typical Relative Spectral Power Distribution

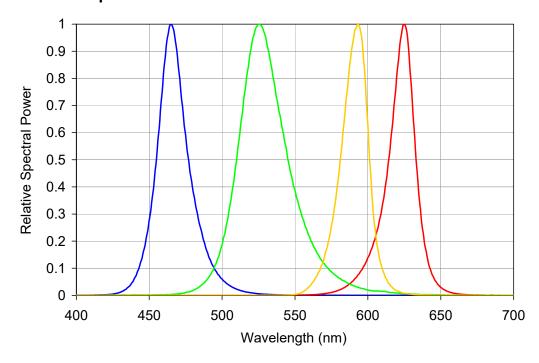


Figure 5: Typical relative spectral power vs. wavelength @ $T_{\rm C}$ = 25°C.



Typical Dominant Wavelength Shift over Forward Current

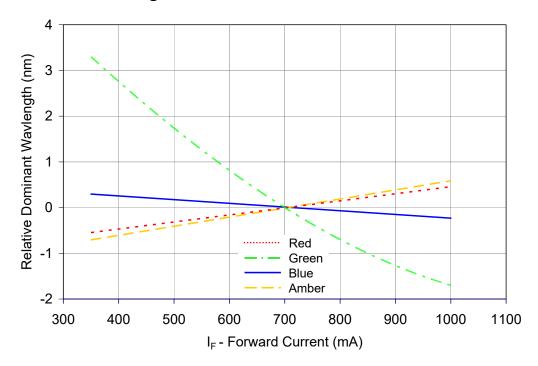


Figure 6: Typical dominant wavelength shift vs. forward current @ T_C = 25°C.

Dominant Wavelength Shift over Temperature

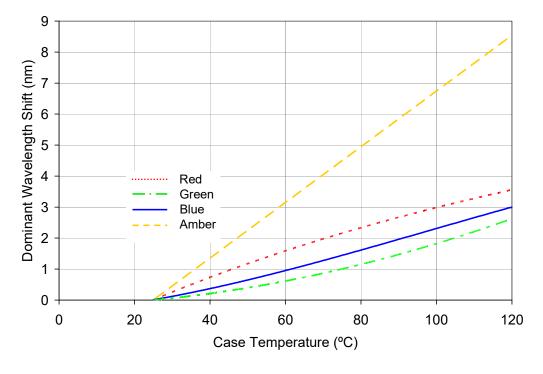


Figure 7: Typical dominant wavelength shift vs. case temperature.



Typical Relative Light Output

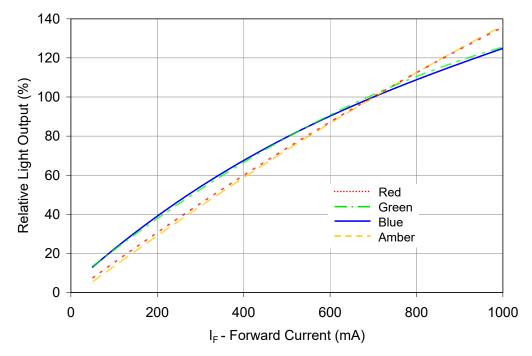


Figure 8: Typical relative light output vs. forward current @ T_C = 25°C.

Typical Relative Light Output over Temperature

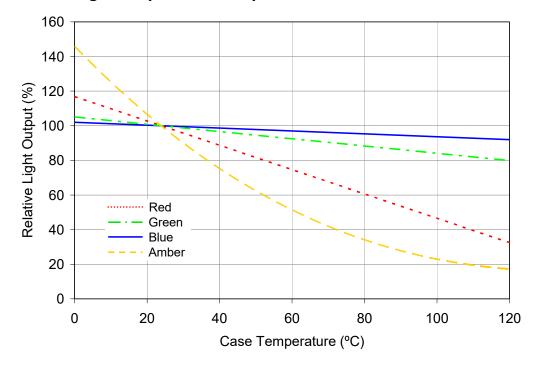


Figure 9: Typical relative light output vs. case temperature.



Typical Forward Current Characteristics

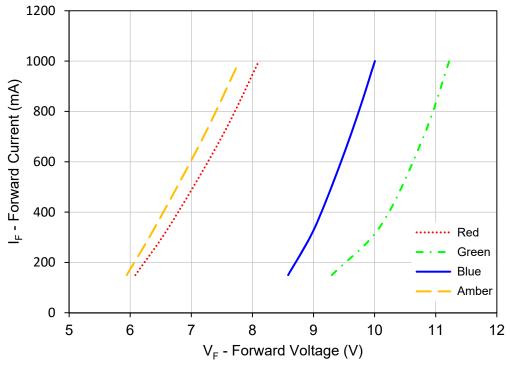


Figure 10: Typical forward current vs. forward voltage @ $T_C = 25$ °C.

Current De-rating

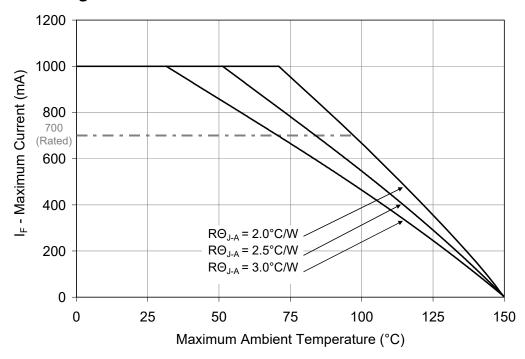


Figure 11: Maximum forward current vs. ambient temperature based on $T_{J(MAX)}$ = 150°C.

Notes for Figure 11:

- Maximum current assumes that all 12 LED dice are operating concurrently at the same current.
- 2. $R\Theta_{J-C}$ [Junction to Case Thermal Resistance] for the LZC-03MA07 is typically <0.7°C/W.
- 3. $R\Theta_{J-A}$ [Junction to Ambient Thermal Resistance] = $R\Theta_{J-C}$ + $R\Theta_{C-A}$ [Case to Ambient Thermal Resistance].



Emitter Tape and Reel Specifications (mm)

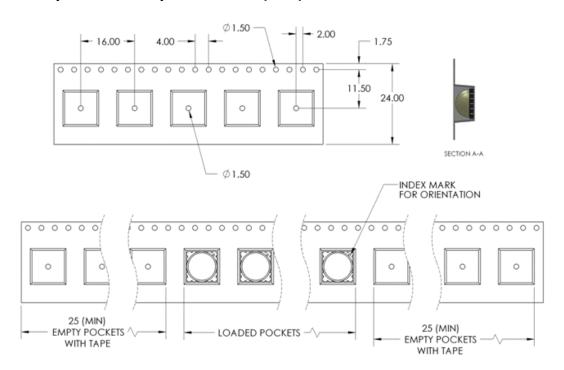


Figure 12: Emitter carrier tape specifications (mm).

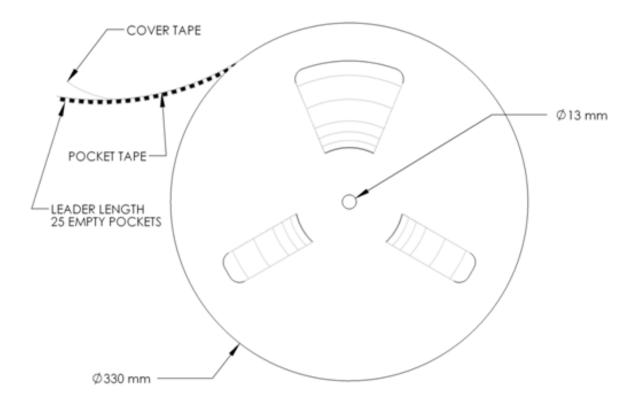


Figure 13: Emitter Reel specifications (mm).



LZC MCPCB Family

Part number	Type of MCPCB	Diameter (mm)	Emitter + MCPCB Thermal Resistance (°C/W)	Typical V _f (V)	Typical I _f (mA)
LZC-Bxxxxx	4-channel	28.3	0.7 + 0.1 = 0.8	7.0 – 12.6	4 x 700

Mechanical Mounting of MCPCB

- O Mechanical stress on the emitter that could be caused by bending the MCPCB should be avoided. The stress can cause the substrate to crack and as a result might lead to cracks in the dies.
- Therefore special attention needs to be paid to the flatness of the heat sink surface and the torque on the screws. Maximum torque should not exceed 1 Nm (8.9 lbf/in).
- Care must be taken when securing the board to the heatsink to eliminate bending of the MCPCB. This
 can be done by tightening the three M3 screws (or #4-40) in steps and not all at once. This is
 analogous to tightening a wheel of an automobile
- O It is recommended to always use plastic washers in combination with three screws. Two screws could more easily lead to bending of the board.
- o If non taped holes are used with self-tapping screws it is advised to back out the screws slightly after tighten (with controlled torque) and retighten the screws again.

Thermal interface material

- O To properly transfer the heat from the LED to the heatsink a thermally conductive material is required when mounting the MCPCB to the heatsink
- There are several materials which can be used as thermal interface material, such as thermal paste, thermal pads, phase change materials and thermal epoxies. Each has pro's and con's depending on the application. For our emitter it is critical to verify that the thermal resistance is sufficient for the selected emitter and its environment.
- o To properly transfer the heat from the MCPCB to the heatsink also special attention should be paid to the flatness of the heatsink.

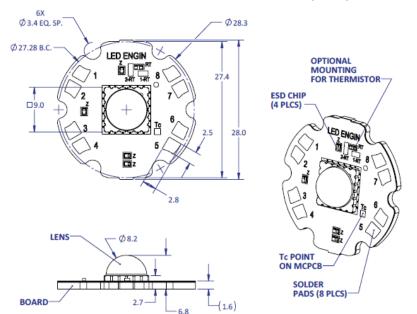
Wire soldering

o For easy soldering of wires to the MCPCB it is advised to preheat the MCPCB on a hot plate to a maximum of 150°. Subsequently apply the solder and additional heat from the solder iron to initiate a good solder reflow. It is recommended to use a solder iron of more than 60W. We advise to use lead free, no-clean solder. For example SN-96.5 AG-3.0 CU 0.5 #58/275 from Kester (pn: 24-7068-7601)



LZC-Bxxxxx

4-Channel MCPCB Mechanical Dimensions (mm)



Pad function with:			
LZC-03MA07			
Pad	Polarity	Ch.	Function
7	Anode +	1	Red
2	Cathode -		
8	Anode +	2	Green
1	Cathode -		
5	Anode +	3	Blue
4	Cathode -		
6	Anode +	4	Amber
3	Cathode -		

Notes:

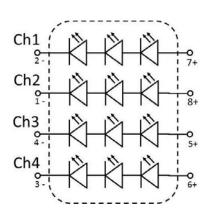
- Unless otherwise noted, the tolerance = ± 0.20 mm.
- Slots in MCPCB are for M3 or #4-40 mounting screws.
- LED Engin recommends using plastic washers to electrically insulate screws from solder pads and electrical traces.
- LED Engin recommends using thermal interface material when attaching the MCPCB to a heat sink.
- The thermal resistance of the MCPCB is: ROC-B 0.1°C/W

Components used

MCPCB: SuperMCPCB (copper)

ESD chips: BZX884-C18

(Bridge Semiconductor) (NXP, for 3 LED dies in series)





Company Information

LED Engin, Inc., based in California's Silicon Valley, specializes in ultra-bright, ultra compact solid state lighting solutions allowing lighting designers & engineers the freedom to create uncompromised yet energy efficient lighting experiences. The LuxiGen™ Platform — an emitter and lens combination or integrated module solution, delivers superior flexibility in light output, ranging from 3W to 90W, a wide spectrum of available colors, including whites, multi-color and UV, and the ability to deliver upwards of 5,000 high quality lumens to a target. The small size combined with powerful output allows for a previously unobtainable freedom of design wherever high-flux density, directional light is required. LED Engin's packaging technologies lead the industry with products that feature lowest thermal resistance, highest flux density and consummate reliability, enabling compact and efficient solid state lighting solutions.

LED Engin is committed to providing products that conserve natural resources and reduce greenhouse emissions.

LED Engin reserves the right to make changes to improve performance without notice.

Please contact sales@ledengin.com or (408) 922-7200 for more information.

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